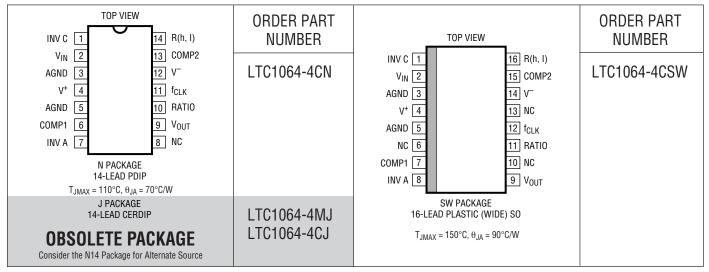
ABSOLUTE MAXIMUM RATINGS (Note 1)

Lead Temperature (Soldering	, 10 sec) 300°C
Operating Temperature Range	9
LTC1064-4M (OBSOLETE)	55°C to 125°C
LTC1064-4C	40°C to 85°C

PACKAGE/ORDER INFORMATION



Consult LTC Marketing for parts specified with wider operating temperature ranges.

ELECTRICAL CHARACTERISTICS The • denotes the specifications which apply over the full operating

temperature range, otherwise specifications are at $T_A = 25^{\circ}$ C. $V_S = \pm 7.5$ V, 50:1, $f_{CLK} = 1$ MHz, $f_C = 20$ kHz, R1 = 10k, TTL clock input level unless otherwise specified.

PARAMETER	CONDITIONS		MIN	ТҮР	MAX	UNITS
Passband Gain Gain TempCo Passband Edge Frequency, f _C	Referenced to 0dB, 1Hz to 0.05f _{CUTOFF}	•	-0.5	0.0002 20 ± 1%	0.1	dB dB/°C kHz
Gain at f _C –3dB Frequency	Referenced to Passband Gain, f _C = 20kHz 50:1 (Cauer Response) 100:1 (Transitional Response)	•	-0.4	20 ± 170 21.5 10	0.7	dB kHz kHz
Passband Ripple (Note 2) Stopband Attenuation Stopband Attenuation	0.1f _C to 0.95f _C Referenced to Passband Gain At 1.7f _{CUTOFF} At 2f _{CUTOFF}	:	-0.15 -56	-60 -80	0.6	dB dB dB
Input Frequency Range	50:1, Pin 10 at V ⁺ 100:1, Pin 10 at V ⁻		0 0		f _{CLK} f _{CLK} /2	kHz kHz
Output Voltage Swing and Operating Input Voltage Range	$V_{S} = \pm 2.37V$ $V_{S} = \pm 5V$ $V_{S} = \pm 7.5V$	•	±1.1 ±3.1 ±5.0			V V V
Total Harmonic Distortion	$V_S = \pm 5V$, Input = $1V_{RMS}$ at 1kHz $V_S = \pm 7.5V$, Input = $3V_{RMS}$ at 1kHz			0.015 0.03		% %
Wideband Noise	$V_S = \pm 5V$, Input = GND 1Hz to 999kHz $V_S = \pm 7.5V$, Input = GND 1Hz to 999kHz			120 135		μV _{RMS} μV _{RMS}

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ELECTRICAL CHARACTERISTICS The \bullet denotes the specifications which apply over the full operating temperature range, otherwise specifications are at T_A = 25°C. V_S = ±7.5V, 50:1, f_{CLK} = 1MHz, f_C = 20kHz, R1 = 10k, TTL clock input level unless otherwise specified.

PARAMETER	CONDITIONS		MIN	ТҮР	MAX	UNITS
Output DC Offset Output DC Offset TempCo	$V_{S} = \pm 7.5V$ $V_{S} = \pm 5V$ $V_{S} = \pm 7.5V$			±50 -100 -200	±160	mV μV/°C μV/°C
Input Impedance			9	13		kΩ
Output Impedance	f _{OUT} = 10kHz			2		Ω
Output Short-Circuit Current	Source/Sink			3/1		mA
Clock Feedthrough	Input = GND			200		μV _{RMS}
Maximum Clock Frequency	$V_{S} = \pm 7.5V$, 50% Duty Cycle (Note 3)				5	MHz
Power Supply Current	$V_{S} = \pm 2.37V, f_{CLK} = 1MHz$ $V_{S} = \pm 5V, f_{CLK} = 1MHz$ $V_{S} = \pm 7.5V, f_{CLK} = 1MHz$	•		11 14 17	22 23 26 28 32	mA mA mA mA mA
Power Supply Voltage Range		•	±2.37		±8	V

Note 1: Absolute Maximum Ratings are those values beyond which the life of a device may be impaired.

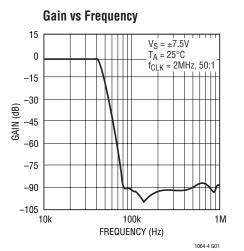
Note 2: For tighter passband ripple specifications please consult with LTC's marketing.

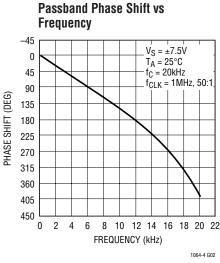
Note 3: Not tested, guaranteed by design.

(ms)

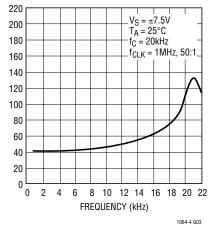
GROUP DELAY

TYPICAL PERFORMANCE CHARACTERISTICS





Passband Group Delay





TYPICAL PERFORMANCE CHARACTERISTICS

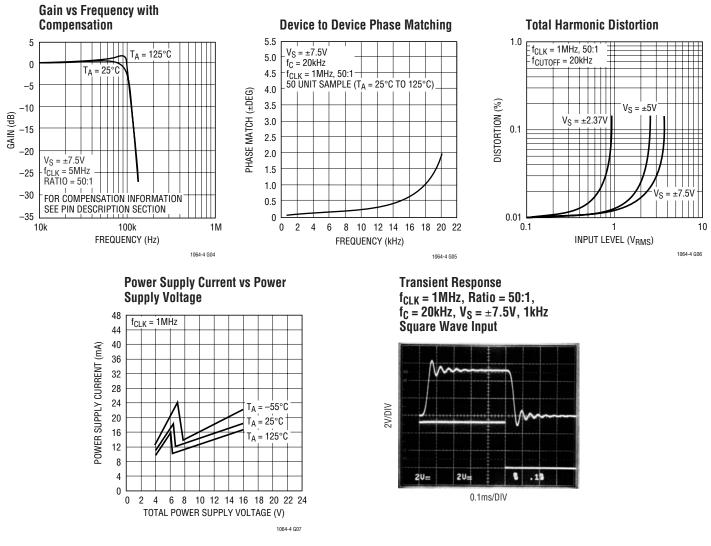


Table 1. Wideband Noise (μV_{RMS}). Input Grounded, f_{CLK} = 1MHz

		$V_S = \pm 2.37V$	$V_S = \pm 5V$	$V_S = \pm 7.5V$
Pin 10 to	fclk/fcutoff	Noise µV _{RMS}	Noise µV _{RMS}	Noise µV _{RMS}
V+	50:1	120	135	145
V-	100:1	100	120	130



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TYPICAL PERFORMANCE CHARACTERISTICS

FREQUENCY(kHz)	GAIN (dB)	PHASE (deg)
0.200	-0.075	-59.990
0.400	- 0.050	-122.400
0.600	0.020	169.300
0.800	0.060	88.500
1.000	0.090	-26.100
1.200	-15.640	-175.100
1.400	-34.700	126.500
1.600	-51.700	87.600
1.800	-68.600	38.400
2.000	-84.110	-47.860

Table 2. Gain/Phase, Pin 10 at V⁺, Typical Response $f_{CUTOFF} = 1$ kHz, V_S = ±5V, T_A = 25°C, $f_{CLK} = 50$ kHz, Ratio = 50:1

Table 3. Gain/Delay, Pin 10 at V⁺, Typical Response f_{CUTOFF} = 1kHz, $\,V_S$ = $\pm 5V,\,T_A$ = 25°C, f_{CLK} = 50kHz, Ratio = 50:1

FREQUENCY(kHz)	GAIN (dB)	DELAY (ms)
0.200	-0.074	0.844
0.300	-0.070	0.867
0.400	-0.050	0.899
0.500	-0.020	0.949
0.600	0.020	1.021
0.700	0.050	1.122
0.800	0.060	1.275
0.900	0.120	1.592
1.000	0.090	2.160
1.100	-5.020	2.070
1.200	-15.650	1.288

Table 4. Gain/Phase, Pin 10 at V⁻, Typical Response f $_{-3dB}$ = 1kHz, $~V_S$ = $\pm 5V,~T_A$ = 25°C, f_CLK = 100kHz, Ratio = 100:1

FREQUENCY(kHz)	GAIN (dB)	PHASE (deg)
0.200	-0.179	-60.090
0.400	-0.440	-122.000
0.600	-0.810	170.800
0.800	-1.480	91.900
1.000	-3.500	-16.300
1.200	-17.720	-140.500
1.400	-35.700	164.800
1.600	-52.700	135.000
1.800	-71.900	114.000
2.000	-96.160	-49.670

Table 5. Gain/Delay, Pin 10 at V⁻, Typical Response f $_{-3dB}$ = 1kHz, $~V_S$ = $\pm 5V,~T_A$ = 25°C, f $_{CLK}$ = 100kHz, Ratio = 100:1

FREQUENCY(kHz)	GAIN (dB)	DELAY (ms)
0.200	-0.174	0.842
0.300	-0.300	0.861
0.400	-0.440	0.888
0.500	-0.610	0.933
0.600	-0.810	0.999
0.700	- 1.090	1.095
0.800	-1.480	1.242
0.900	-2.080	1.503
1.000	-3.500	1.832
1.100	-8.720	1.724
1.200	- 17.720	1.183

Table 6. Gain/Phase, Pin 10 at GND $V_S=\pm 5V,\,T_A=25^\circ C$

FREQUENCY(kHz)	GAIN (dB)	PHASE (deg)
0.200	- 0.383	-47.140
0.400	- 1.000	-92.000
0.600	- 1.300	-134.300
0.800	-0.280	-178.800
1.000	2.670	109.200
1.200	-3.500	6.000
1.400k	-12.510	-47.400
1.600	-20.000	-88.800
1.800	-27.300	-127.800
2.000	-35.000	-164.200



TYPICAL PERFORMANCE CHARACTERISTICS

Table 7. Gain/Phase for Figure 6. Typical Response, Pin 10 at V⁺, f_{CUTOFF} = 40kHz, $V_S = \pm 7.5V$, f_{CLK} = 2MHz, Ratio = 50:1

Table 8. Gain/Phase for Figure 7. Typical Response, Pin 10 at V⁺, f_{CUTOFF} = 100kHz, $V_S = \pm 7.5V$, $T_A = 25^{\circ}$ C, f_{CLK} = 5MHz, Ratio = 50:1

• •					
FREQUENCY (kHz)	GAIN (dB)	PHASE (deg)	FREQUENCY (kHz)	GAIN (dB)	PHASE (deg)
10.000	-0.094	-75.900	10.000	-0.096	-32.390
12.000	-0.100	-91.400	20.000	-0.100	-64.900
14.000	-0.090	-107.200	30.000	-0.080	-98.100
16.000	-0.080	-123.300	40.000	-0.040	-132.300
18.000	-0.060	-139.600	50.000	0.020	-168.200
20.000	-0.040	-156.500	60.000	0.070	153.600
22.000	-0.020	-173.800	70.000	0.040	112.100
24.000	0.000	168.200	80.000	-0.120	66.400
26.000	0.020	149.400	90.000	-0.460	14.600
28.000	0.030	130.000	100.000	-1.310	-49.300
30.000	0.020	109.400	110.000	-5.640	-129.000
32.000	0.010	87.700			
34.000	-0.020	64.600	120.000	-14.530	167.800
36.000	-0.030	39.500	130.000	-23.800	126.700
38.000	-0.010	11.400	140.000	-32.600	96.200
40.000	-0.070	-22.000	150.000	-41.000	71.300
42.000	-0.920	-64.100	160.000	-49.200	49.200
44.000	-4.000	-110.100	170.000	-57.500	29.000
46.000	-8.970	-147.000	180.000	-66.500	9.800
48.000	-14.320	-173.500	190.000	-77.770	-2.320
50.000	-19.460	166.800	200.000	-92.050	76.740
		•			

Table 9. Gain/Phase for Figure 7. Typical Response, Pin 10 at V⁺ f_{CUTOFF} = 100kHz, $V_S = \pm 7.5V$, $T_A = 125^{\circ}C$, $f_{CLK} = 5MHz$, Ratio = 50:1

FREQUENCY (kHz)	GAIN (dB)	PHASE (deg)	FREQUENCY (kHz)	GAIN (dB)	PHASE (deg)
10.000	-0.071	-33.800	110.000	-7.420	172.100
20.000	-0.040	-67.800	120.000	-18.240	119.400
30.000	0.050	-102.500	130.000	-28.000	83.300
40.000	0.190	-138.300	140.000	-37.000	54.000
50.000	0.410	-176.100	150.000	-45.700	-27.600
60.000	0.670	143.100	160.000	-54.300	2.100
70.000	0.920	98.400	170.000	-63.300	-24.900
80.000	1.150	48.200	180.000	-73.610	-60.210
90.000	1.530	-10.900	190.000	-85.300	-138.990
100.000	1.110	-96.500	200.000	-83.390	129.580





PIN FUNCTIONS (Pin Numbers Refer to the 14-Pin Package)

INV C, COMP1, INV A, COMP2 (Pins 1, 6, 7 and 13): To obtain a Cauer response with minimum passband ripple and cutoff frequencies above 20kHz, compensating components are required. Figure 6 uses \pm 7.5V power supplies and compensation components to achieve up to 40kHz *sweepable* cutoff frequencies and \pm 0.1dB passband ripple. Table 7 lists the typical amplitude response of Figure 6. Figure 7 illustrates the compensation scheme required to obtain a 100kHz cutoff frequency; Graph 4 and Tables 8 and 9 list the typical response of Figure 7 for 25°C and 125°C ambient temperature. As shown the ripple increases at high temperatures but still a \pm 0.25dB figure can be obtained for ambient temperatures below 70°C.

 V_{IN} , V_{OUT} (Pins 2, 9): The input Pin 2 is connected to a 12k resistor tied to the inverting input of an op amp. Pin 2 is protected against static discharge. The device's output, Pin 9, is the output of an op amp which can typically source/sink 3mA/1mA. Although the internal op amps are unity gain stable, driving long coax cables is not recommended.

When testing the device for noise and distortion, the output, Pin 9, should be buffered (Figure 4). *The op amp power supply wire (or trace) should be connected directly to the power source.* To eliminate any output clock feedthrough, Pin 9 should be buffered with a simple R, C lowpass filter (Figure 5). The cutoff frequency of the output filter should be $f_{CLK}/3$.

AGND (Pins 3, 5): For dual supply operation these pins should be connected to a ground plane. For single supply operation both pins should be tied to one half supply (Figure 2).

V⁺, **V⁻** (Pins 4, 12): Should be bypassed with a 0.1μ F capacitor to an adequate analog ground. Low noise, nonswitching power supplies are recommended. *To avoid latchup when the power supplies exhibit high turn-on transients, a 1N5817 Schottky diode should be added from the V⁺ and V⁻ pins to ground (Figures 1 and 2).*

INV A, R(h, I) (Pins 7, 14): A very short connection between Pin 7 and Pin 14 is recommended. This connection should be preferably done under the IC package. In a breadboard, use a one inch, or less, shielded coaxial cable; the shield should be grounded. In a PC board, use a one inch trace or less; surround the trace by a ground plane.

NC (Pin 8): Pin 8 is not internally connected, it should be preferably grounded.

50/100 Ratio (Pin 10): For an f_{CLK}/f_C ratio of 50:1, Pin 10 should be tied to V⁺. For an f_{CLK}/f_{-3dB} ratio of 100:1, Pin 10 should be tied to V⁻. When Pin 10 is at midsupplies (i.e. ground), the filter response is neither Cauer nor transitional. Table 6 illustrates this response. Bypassing Pin 10 with a 0.1µF capacitor reduces the already small clock feedthrough.



TYPICAL APPLICATIONS

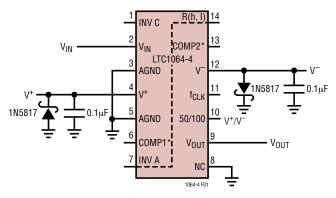


Figure 1. Using Schottky Diodes to Protect the IC from Power Supply Spikes

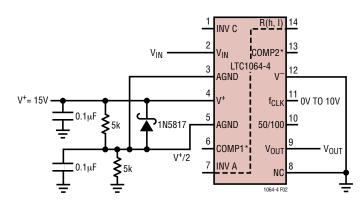


Figure 2. Single Supply Operation. If Fast Power Up or Down Transients are Expected, Use a 1N5817 Schottky Diode Between Pin 4 and Pin 5.

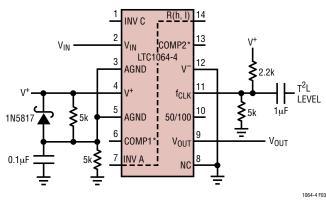


Figure 3. Level Shifting the Input T^2L Clock for Single Supply Operation ${\geq}6V.$

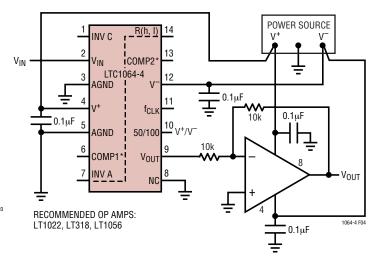


Figure 4. Buffering the Filter Output. The Buffer Op Amp Should Not Share the LTC1064-4 Power Lines.

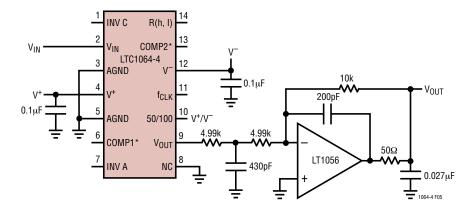
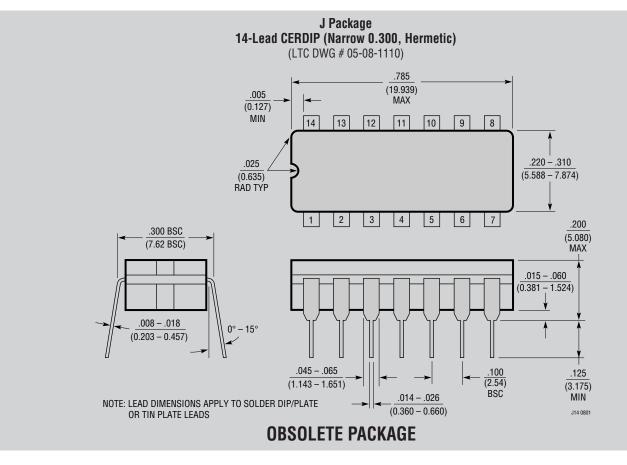


Figure 5. Adding an Output Buffer-Filter to Eliminate Any Clock Feedthrough. Passband Error of Output Buffer is ± 0.1 dB to 50kHz, -3dB at 94kHz.



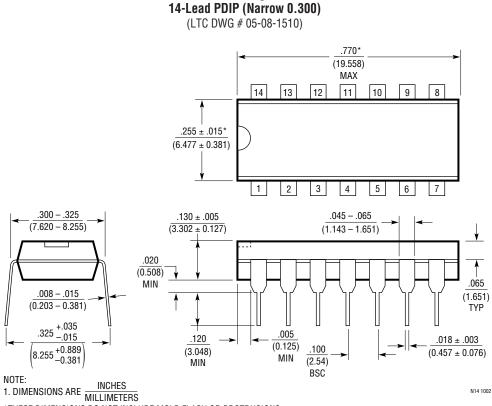
PACKAGE DESCRIPTION





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PACKAGE DESCRIPTION



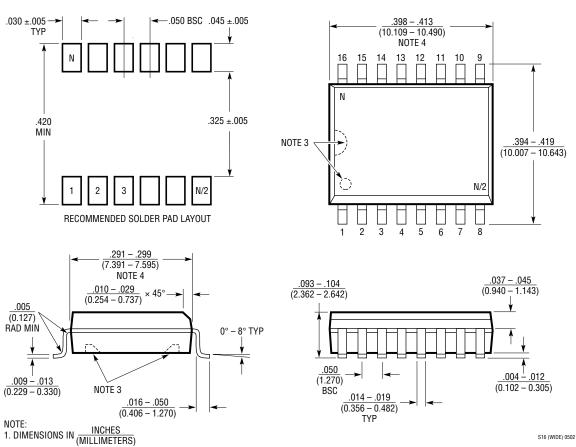
N Package

*THESE DIMENSIONS DO NOT INCLUDE MOLD FLASH OR PROTRUSIONS. MOLD FLASH OR PROTRUSIONS SHALL NOT EXCEED .010 INCH (0.254mm)





PACKAGE DESCRIPTION



SW Package 16-Lead Plastic Small Outline (Wide .300 Inch) (Reference LTC DWG # 05-08-1620)

2. DRAWING NOT TO SCALE

DISTURBANCE TO SURLE
PIN 1 IDENT, NOTCH ON TOP AND CAVITIES ON THE BOTTOM OF PACKAGES ARE THE MANUFACTURING OPTIONS. THE PART MAY BE SUPPLIED WITH OR WITHOUT ANY OF THE OPTIONS

4. THESE DIMENSIONS DO NOT INCLUDE MOLD FLASH OR PROTRUSIONS.

MOLD FLASH OR PROTRUSIONS SHALL NOT EXCEED .006" (0.15mm)



TYPICAL APPLICATIONS

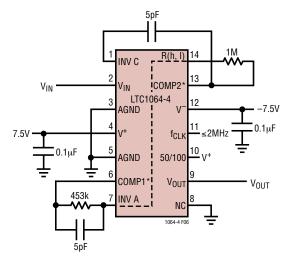


Figure 6. Compensating LTC1064-4 for Passband Ripple of $\pm 0.1dB$ and f_{CUTOFF} Sweeps to 40kHz.

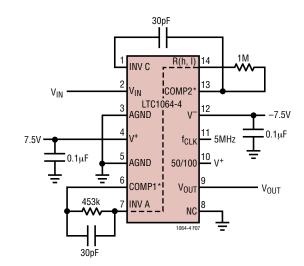


Figure 7. Compensating LTC1064-4 for f_{CUTOFF} = 100kHz, Gain at f_{CUTOFF} = –1.3dB, Table 8.

RELATED PARTS

PART NUMBER	DESCRIPTION	COMMENTS
LTC1069-1	8th Order Elliptic Lowpass	S0-8 Package, Low Power
LTC1069-6	Single Supply, 8th Order Elliptic Lowpass	S0-8 Package, Very Low Power
LTC1569-6	DC Accurate, 10th Order Lowpass	Internal Precision Clock, Low Power, S0-8 Package
LTC1569-7	DC Accurate, 10th Order Lowpass	Internal Precision Clock, Delay Equalized, S0-8 Package

